
Sup/IRBuck™

USER GUIDE FOR IR3853 EVALUATION BOARD

DESCRIPTION

The IR3853 is a synchronous buck converter, providing a compact, high performance and flexible solution in a small 4mmx5mm Power QFN package.

Key features offered by the IR3853 include programmable soft-start ramp, precision 0.7V reference voltage, Power Good, thermal protection, over voltage protection, programmable switching frequency, synchronization to external clock, Sequence input, Enable input, input under-voltage lockout for proper start-up, and pre-bias start-up.

An output over-current protection function is implemented by sensing the voltage developed across the on-resistance of the synchronous rectifier MOSFET for optimum cost and performance.

This user guide contains the schematic and bill of materials for the IR3853 evaluation board. The guide describes operation and use of the evaluation board itself. Detailed application information for IR3853 is available in the IR3853 data sheet.

BOARD FEATURES

- $V_{in} = +12V$ (13.2V Max)
- $V_{cc} = +5V$ (5.5V Max)
- $V_{out} = +1.8V @ 0- 4A$
- $F_s = 600kHz$
- $L = 1.5\mu H$
- $C_{in} = 2 \times 10\mu F$ (ceramic 1206) + $330\mu F$ (electrolytic)
- $C_{out} = 4 \times 22\mu F$ (ceramic 0805)

CONNECTIONS and OPERATING INSTRUCTIONS

A well regulated +12V input supply should be connected to VIN+ and VIN-. A maximum 4A load should be connected to VOUT+ and VOUT-. The connection diagram is shown in Fig. 1 and inputs and outputs of the board are listed in Table I.

IR3853 has two input supplies, one for biasing (Vcc) and the other as input voltage (Vin). Separate supplies should be applied to these inputs. Vcc input should be a well regulated 4.5V-5.5V supply and it would be connected to Vcc+ and Vcc-.

If single 12V application is required connect R7 (zero Ohm resistor) which enables the on board bias regulator (see schematic). In this case there is no need of external Vcc supply.

The output can track a sequencing input at the start-up. *For sequencing application, R16 should be removed and the external sequencing source should be applied between Seq. and Agnd.* The value of R14 and R28 can be selected to provide the desired ratio between the output voltage and the tracking input. *For proper operation of IR3853, the voltage at Seq. pin should not exceed Vcc.*

Table I. Connections

| Connection | Signal Name |
|------------|--------------------------------|
| VIN+ | V_{in} (+12V) |
| VIN- | Ground of V_{in} |
| Vcc+ | Vcc input |
| Vcc- | Ground for Vcc input |
| VOUT- | Ground of V_{out} |
| VOUT+ | V_{out} (+1.8V) |
| Enable | Enable |
| Seq. | Sequence Input |
| PGood | Power Good Signal |
| SYNC | External Synchronization Clock |

LAYOUT

The PCB is a 4-layer board. All of layers are 2 Oz. copper. The IR3853 SupIRBuck and all of the passive components are mounted on the top side of the board.

Power supply decoupling capacitors, the Bootstrap capacitor and feedback components are located close to IR3853. The feedback resistors are connected to the output voltage at the point of regulation and are located close to the SupIRBuck. To improve efficiency, the circuit board is designed to minimize the length of the on-board power ground current path.

Connection Diagram

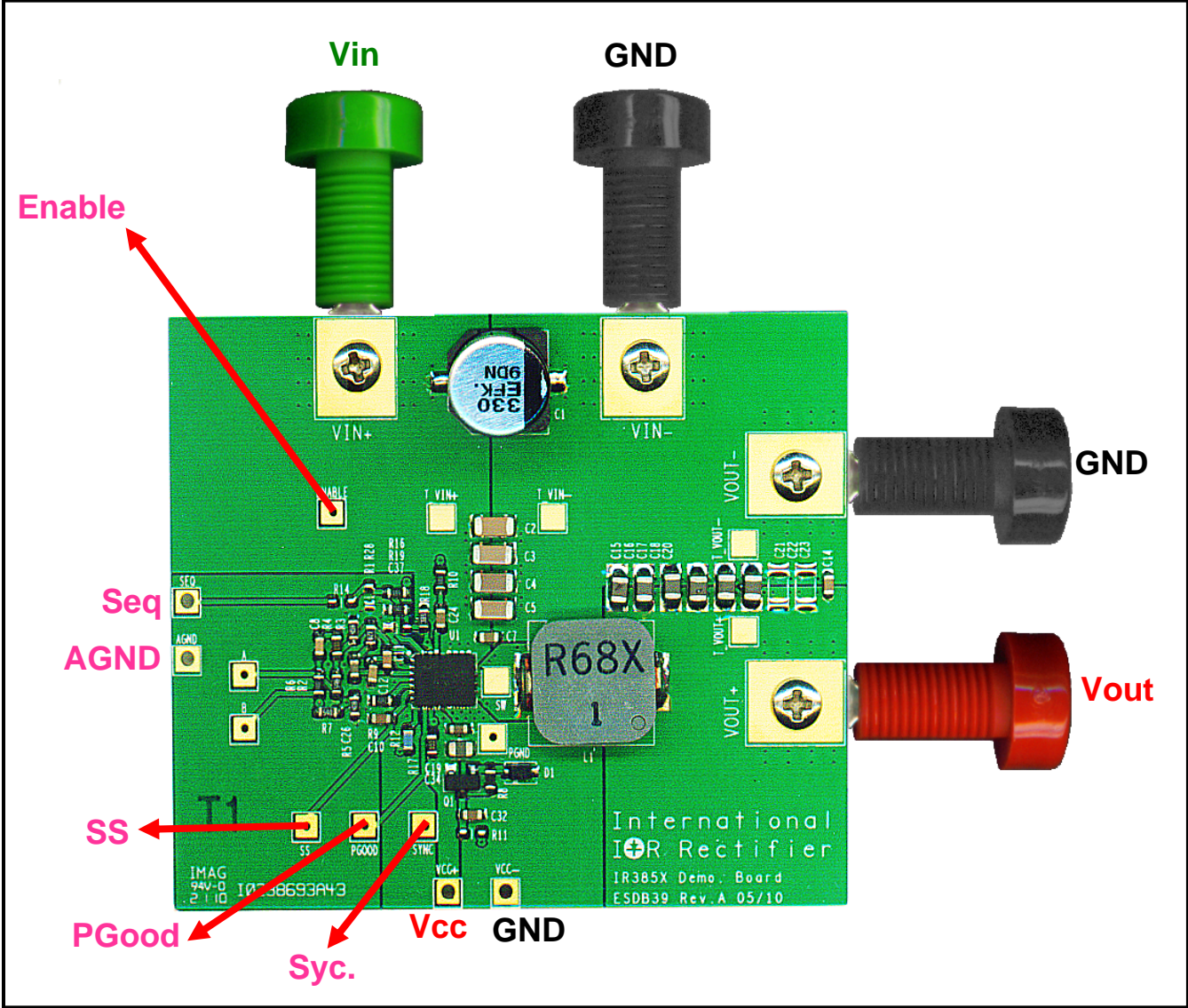


Fig. 1: Connection diagram of IR385x evaluation boards

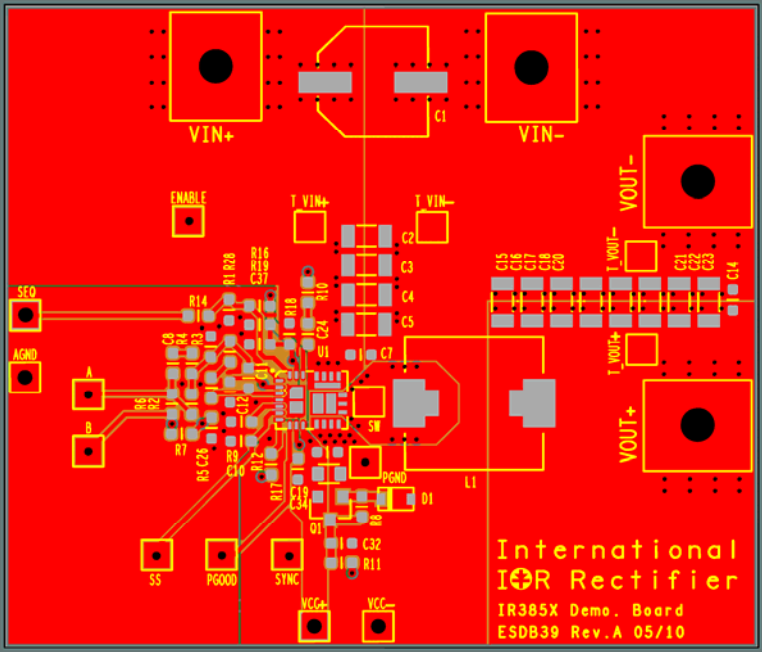


Fig. 2: Board layout, top overlay

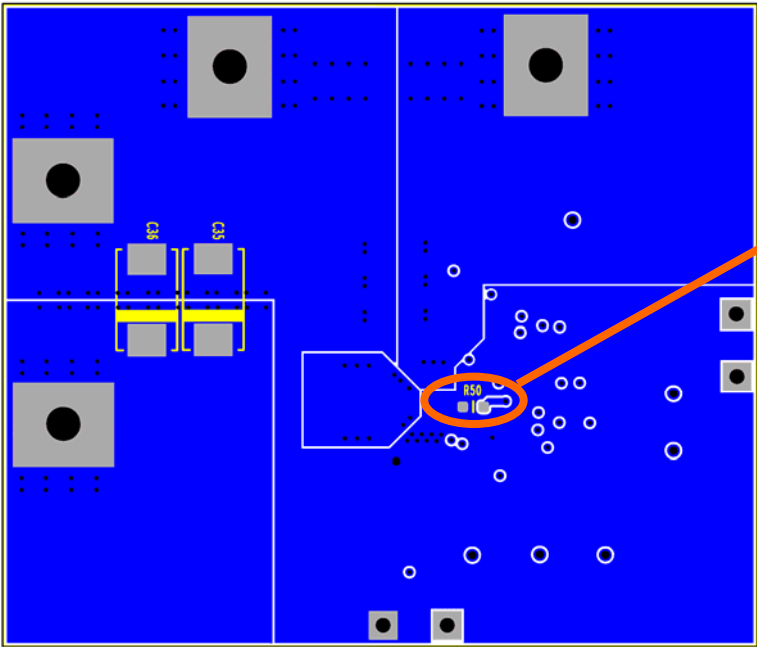


Fig. 3: Board layout, bottom overlay (rear view)

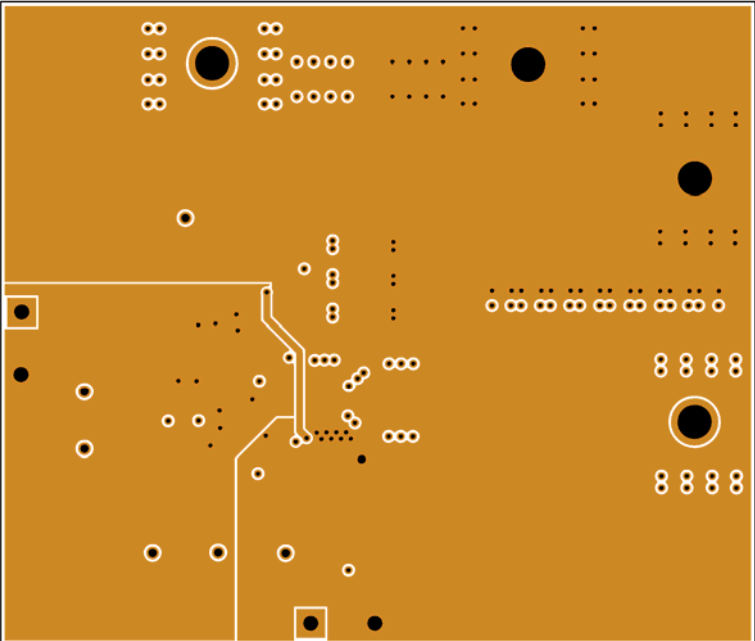


Fig. 4: Board layout, mid-layer I.

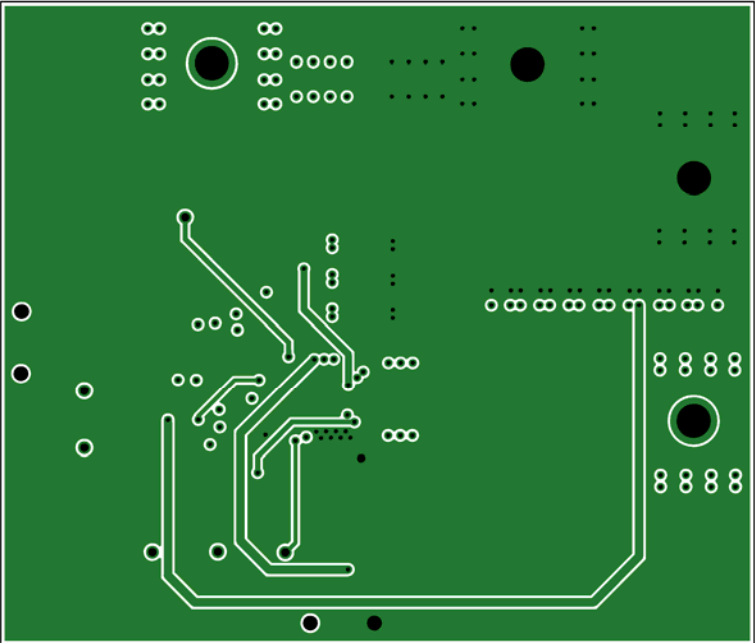
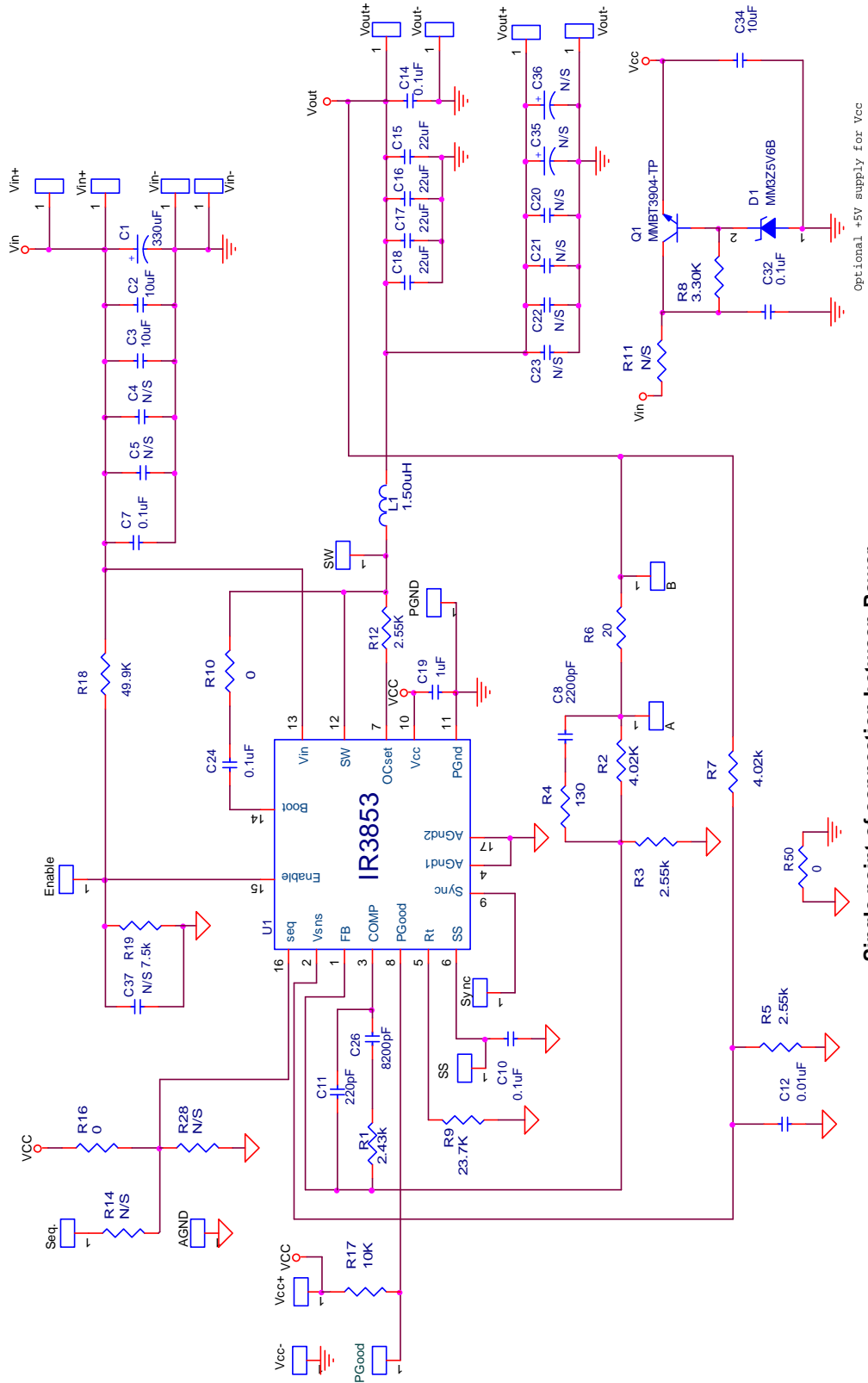


Fig. 5: Board layout, mid-layer II.



Single point of connection between Power
Ground and Signal ("analog") Ground

Fig. 6: Schematic of the IR3853 evaluation board

Bill of Materials

| Item | Quantity | Part Reference | Value | Description | Manufacturer | Part Number |
|------|----------|--------------------|--------------|-----------------------------------|-------------------------|--------------------|
| 1 | 1 | C1 | 330uF | SMD Electrolytic, Fsize, 25V, 20% | Panasonic | EEV-FK1E331P |
| 2 | 2 | C3 C2 | 10uF | 1206, 25V, X5R, 20% | Murata | GRM31CR61E106MA12L |
| 3 | 1 | C34 | 10uF | 0805, 10V, X5R, 20% | TDK | C2012X5R1A106KB |
| 4 | 1 | C19 | 1uF | 0603, 16V, X7R, 10% | TDK | C1608X7R1C105K |
| 5 | 1 | C12 | 0.01uF | 0603, 50V, X7R, 10% | TDK | C1608X7R1H103K |
| 6 | 5 | C7 C10 C14 C24 C32 | 0.1uF | 0603, 25V, X7R, 10% | TDK | C1608X7R1H104KB |
| 7 | 1 | C8 | 2200pF | 0603, 50V, NP0, 5% | Murata | GRM1885C1H222JA01D |
| 8 | 1 | C11 | 220pF | 0603, 50V, NP0, 5% | Murata | GRM1885C1H221JA01D |
| 9 | 4 | C15 C16 C17 C18 | 22uF | 0805, 6.3V, X5R, 20% | TDK | C2012X5R0J226M |
| 10 | 1 | C26 | 8200pF | 0603, 50V, X7R, 10% | Murata | GRM188R71H822KA01D |
| 11 | 1 | D1 | MM3Z5V6B | MM3Z5V6B,Zener, 5.6V | Fairchild | MM3Z5V6B |
| 12 | 1 | L1 | 1.5uH | 7x7x5mm, 20%, 6.7mOhm | Cyntec | PCMB065T-1R5MS |
| 13 | 1 | Q1 | MMBT3904/SOT | NPN, 40V, 200mA, SOT-23 | Fairchild | MMBT3904/SOT |
| 14 | 1 | R8 | 3.3k | Thick Film, 0603,1/10W,1% | Rohm | MCR03EZPFX3301 |
| 15 | 1 | R18 | 49.9k | Thick Film, 0603,1/10W,1% | Rohm | MCR03EZPFX4992 |
| 16 | 1 | R4 | 130 | Thick Film, 0603,1/10W,1% | Panasonic - ECG | ERJ-3EKF1300V |
| 17 | 1 | R6 | 20 | Thick Film, 0603,1/10 W,1% | Vishey/Dale | CRCW060320R0FKEA |
| 18 | 1 | R9 | 23.7k | Thick Film, 0603,1/10W,1% | Rohm | MCR03EZPFX2372 |
| 19 | 3 | R16 R10 R50 | 0 | Thick Film, 0603,1/10 W,5% | Vishay/Dale | CRCW06030000Z0EA |
| 20 | 3 | R3 R5 R12 | 2.55k | Thick Film, 0603,1/10 W,1% | Rohm | MCR03EZPFX2551 |
| 21 | 1 | R17 | 10.0k | Thick Film, 0603,1/10W,1% | Rohm | MCR03EZPFX1002 |
| 22 | 1 | R19 | 7.50k | Thick Film, 0603,1/10W,1% | Rohm | MCR03EZPFX7501 |
| 23 | 1 | R1 | 2.43k | Thick Film, 0603,1/10W,1% | Rohm | MCR03EZPFX2431 |
| 24 | 2 | R2 R7 | 4.02k | Thick Film, 0603,1/10W,1% | Rohm | MCR03EZPFX4021 |
| 25 | 1 | U1 | IR3853 | PQFN 4mmx5mm, 4A SuplRBuck | International Rectifier | IR3853MPbF |

TYPICAL OPERATING WAVEFORMS

$V_{in}=12.0V$, $V_{cc}=5V$, $V_o=1.8V$, $I_o=0-4A$, Room Temperature, No Air Flow

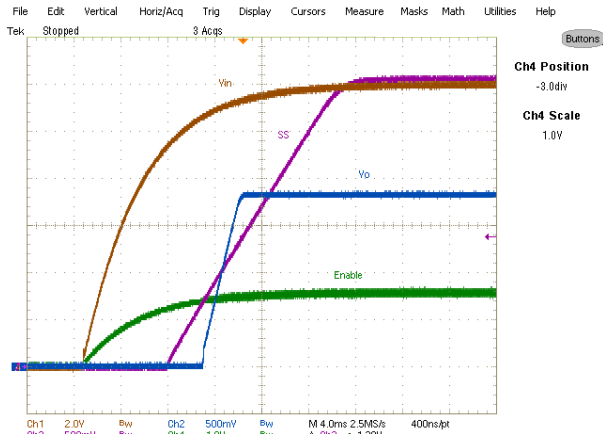


Fig. 7. Start up at 4A Load
Ch₁:V_{in}, Ch₂:V_o, Ch₃:V_{ss}, Ch₄:Enable

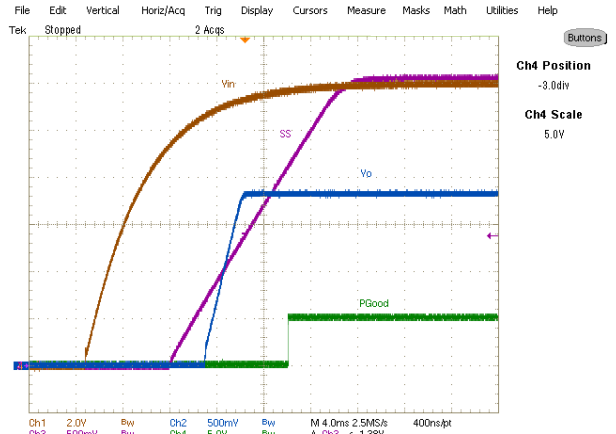


Fig. 8. Start up at 4A Load,
Ch₁:V_{in}, Ch₂:V_o, Ch₃:V_{ss}, Ch₄:V_{PGGood}

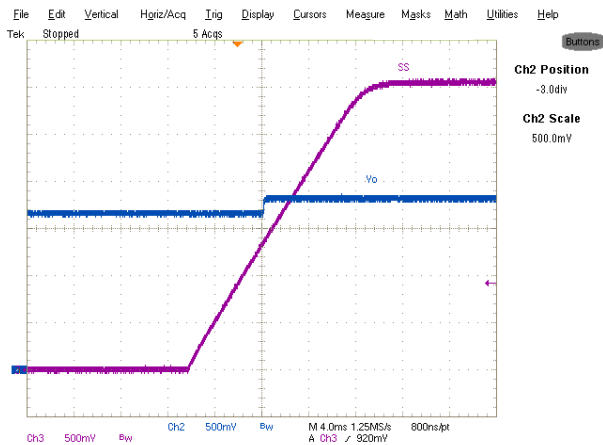


Fig. 9. Start up with 1.62V Pre Bias, 0A Load, Ch₂:V_o, Ch₃:V_{ss}

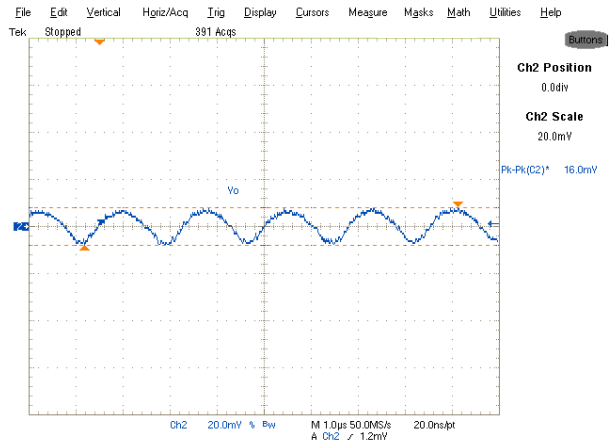


Fig. 10. Output Voltage Ripple, 4A load
Ch₂: V_o

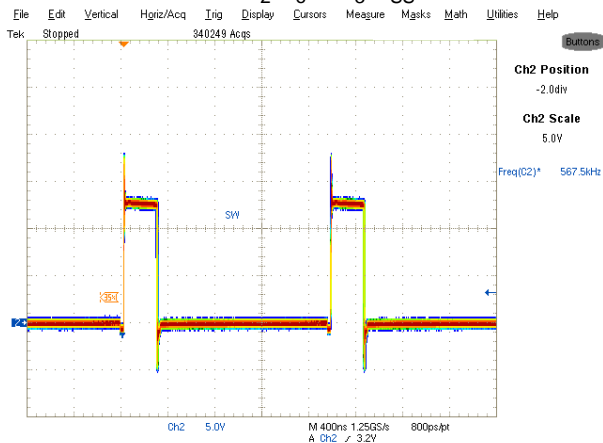


Fig. 11. Inductor node at 4A load
Ch₂:LX

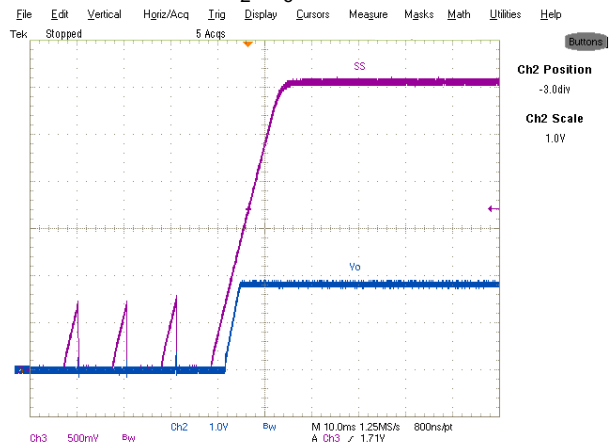


Fig. 12. Short (Hiccup) Recovery
Ch₂:V_o, Ch₃:V_{ss}

TYPICAL OPERATING WAVEFORMS

Vin=12V, Vcc=5V, Vo=1.8V, Io=0-4A, Room Temperature, No Air Flow

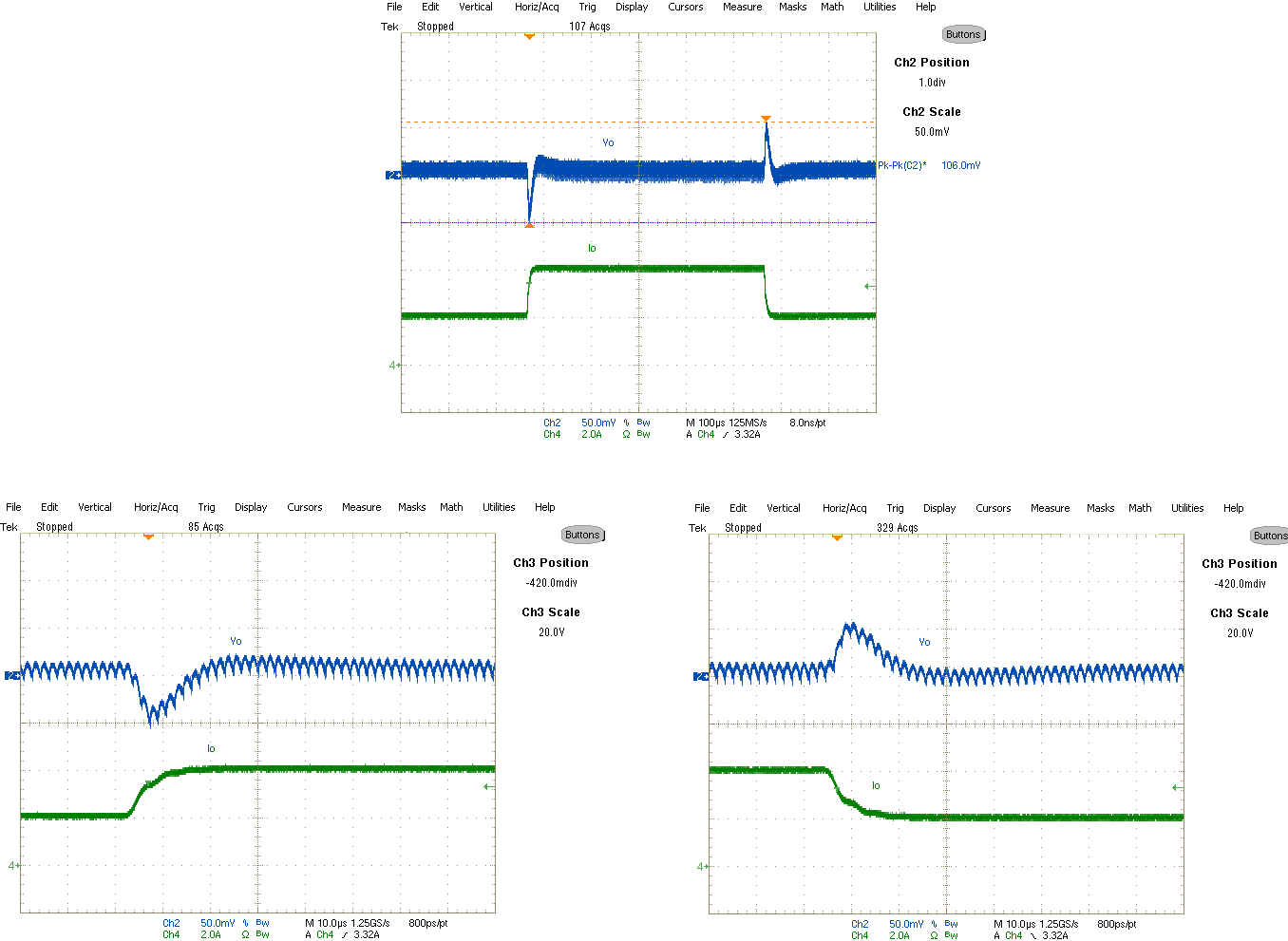


Fig. 13. Transient Response, 2A to 4A step 2.5A/μs
 Ch₂:V_o, Ch₄:I_o

TYPICAL OPERATING WAVEFORMS

Vin=12V, Vcc=5V, Vo=1.8V, Io=4A, Room Temperature, No Air Flow

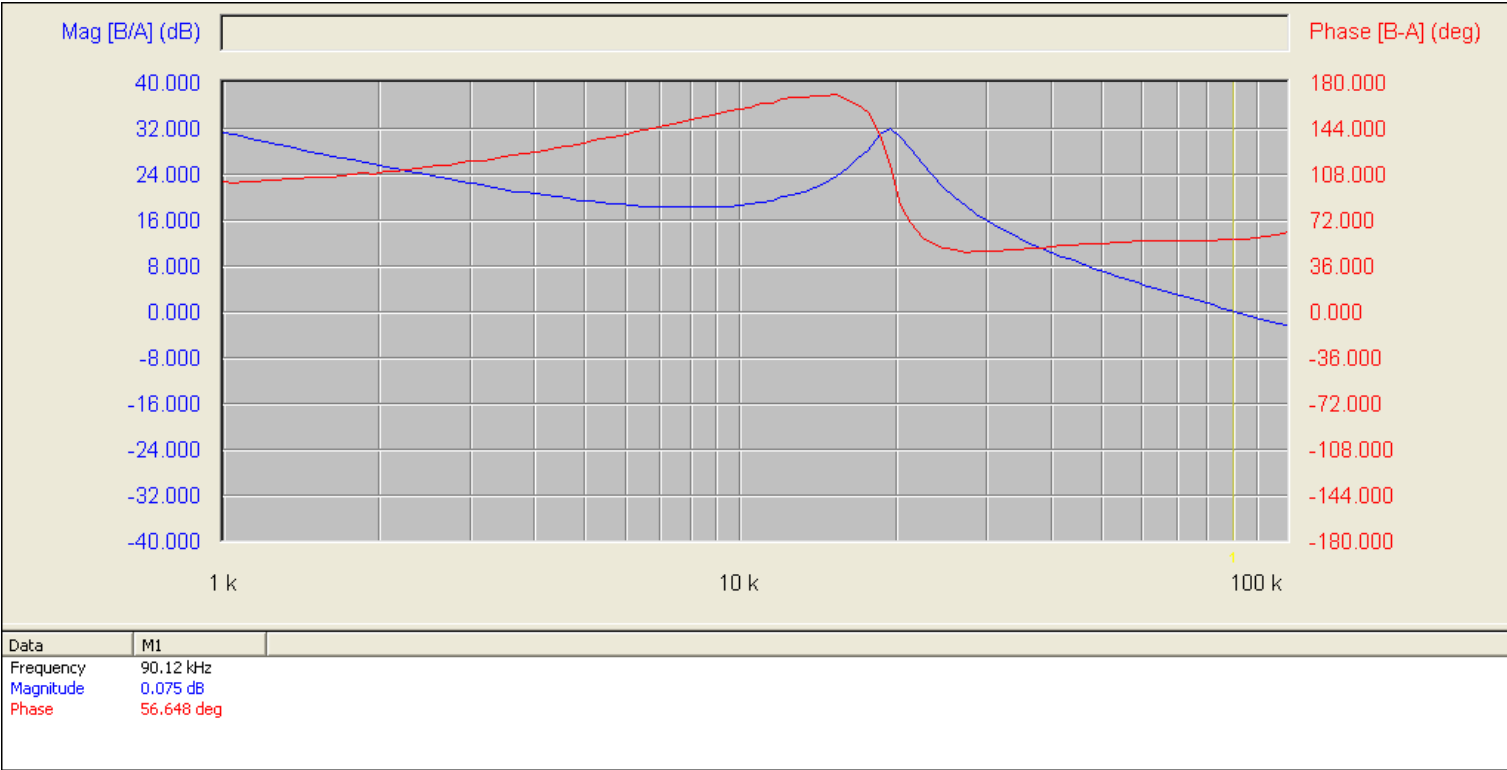


Fig. 14. Bode Plot at 4A load shows a bandwidth of 90.1kHz and phase margin of 56.7 degrees

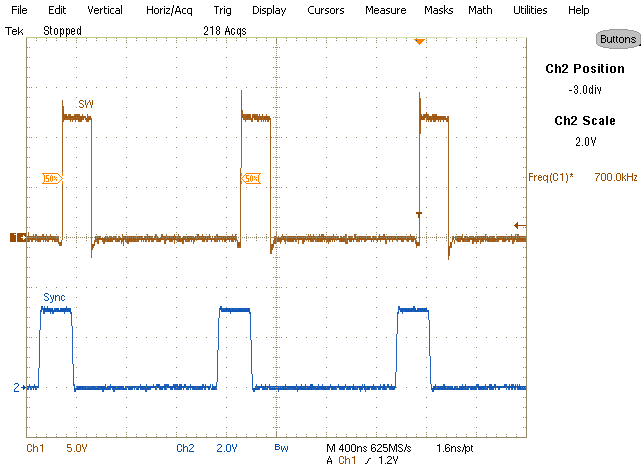


Fig. 15. Synchronization to External Clock
Ch₁: SW node, Ch₂: Sync. Pin

TYPICAL OPERATING WAVEFORMS

$V_{in}=12V$, $V_o=1.8V$, $I_o=0-4A$, Room Temperature, No Air Flow

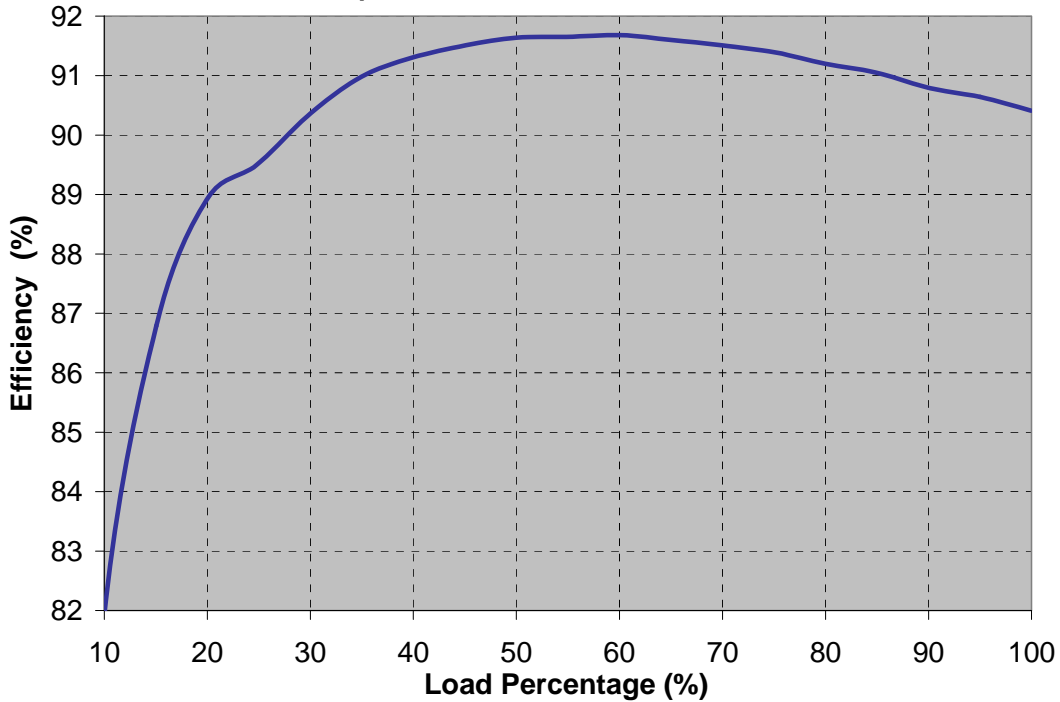


Fig.16: Efficiency versus load current

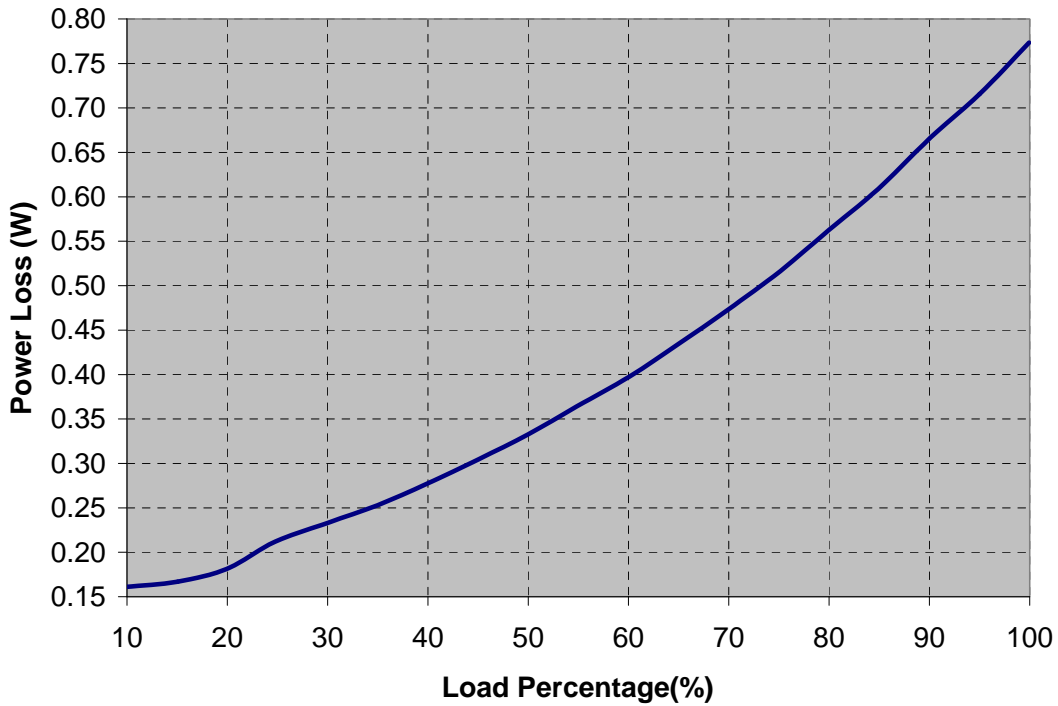


Fig.17: Power loss versus load current

THERMAL IMAGES

Vin=12V, Vo=1.8V, Io=4A, Room Temperature, No Air Flow



Fig. 18: Thermal Image at 4A load
Test points 1 and 2 are IR3853 and inductor, respectively.

Simultaneous Tracking at Power Up and Power Down
Vin=12V, Vo=1.8V, Io=4A, Room Temperature, No Air Flow

In order to run the IR3853 in the simultaneous tracking mode, the following steps should be taken:

- Remove R16 from the board.
- Set the value of R14 and R28 as R2 (4.02K) and R3 (2.55K), respectively.
- Connect the controlling input across SEQ and AGND test points on the board. This voltage should be at least 1.15 time greater than Vo. For the following test results a 0-3.3V source is applied to SEQ input.
- The controlling input should be applied after the SS pin is clamped to 3.0V.

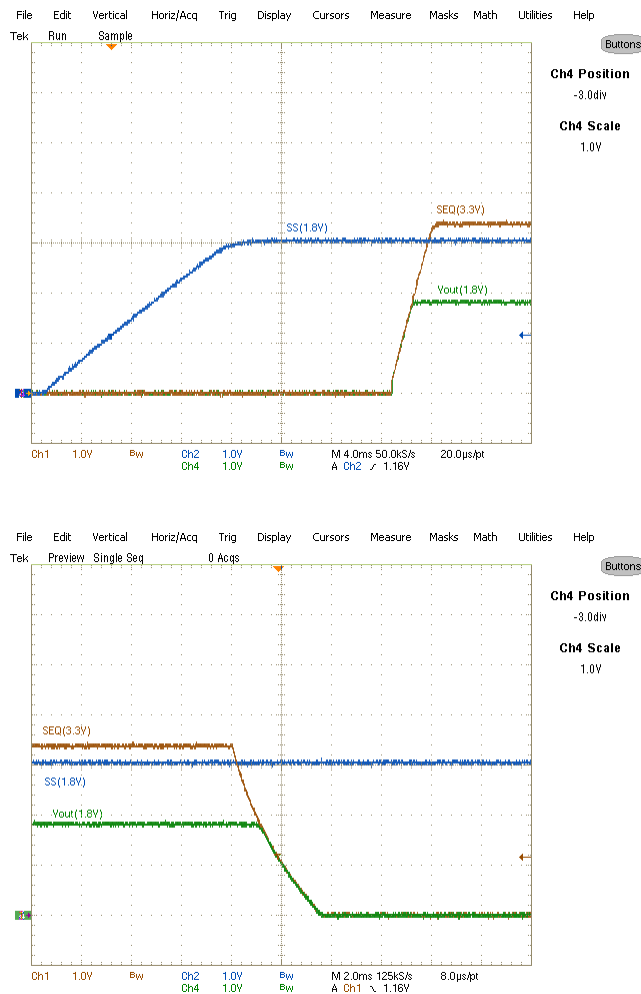
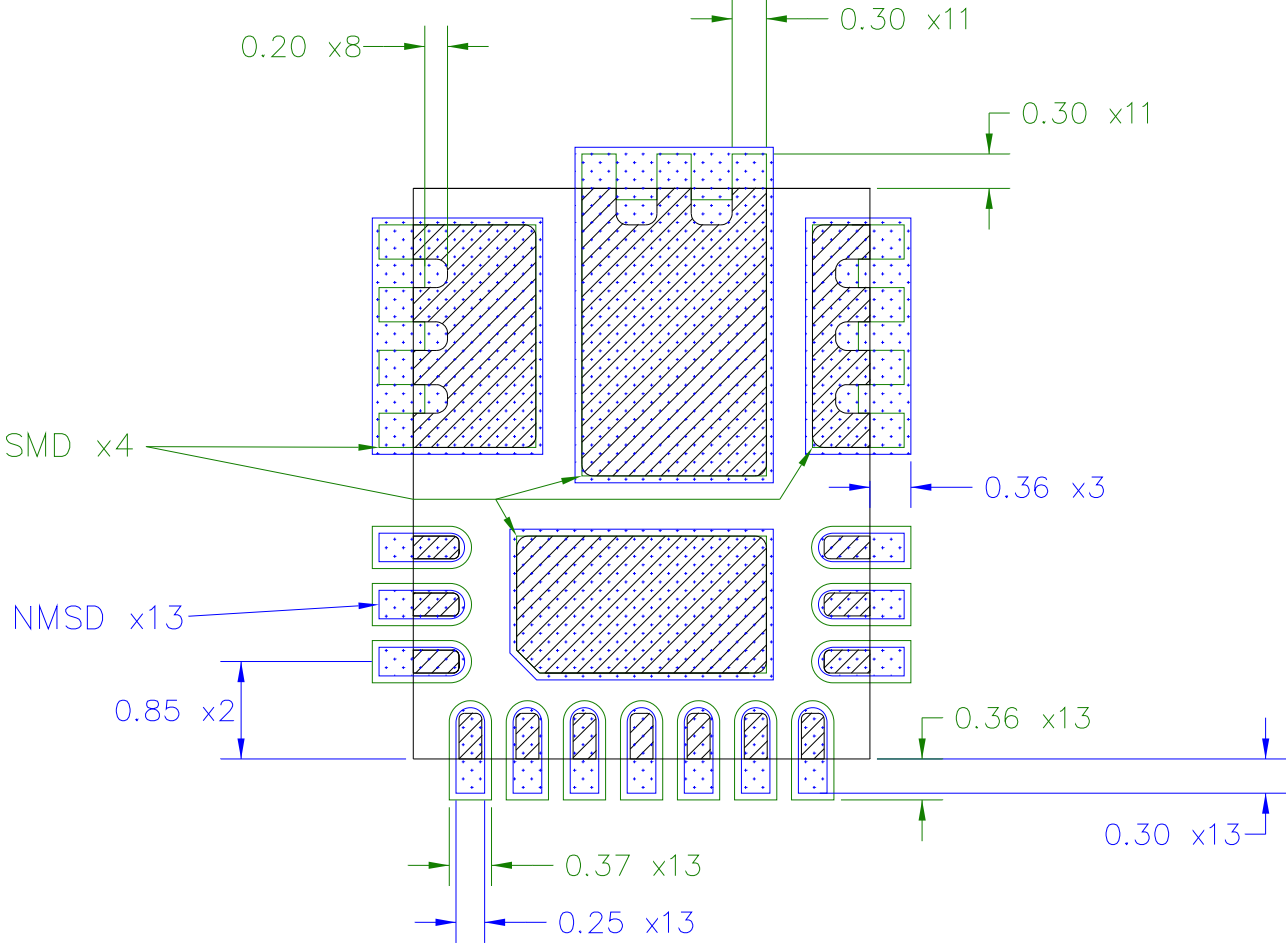





Fig. 19: Simultaneous Tracking a 3.3V input at power-up and shut-down
 Ch1: SEQ (3.3V) Ch3:Vout (1.8V) Ch4: SS (1.8V)

PCB Metal and Components Placement

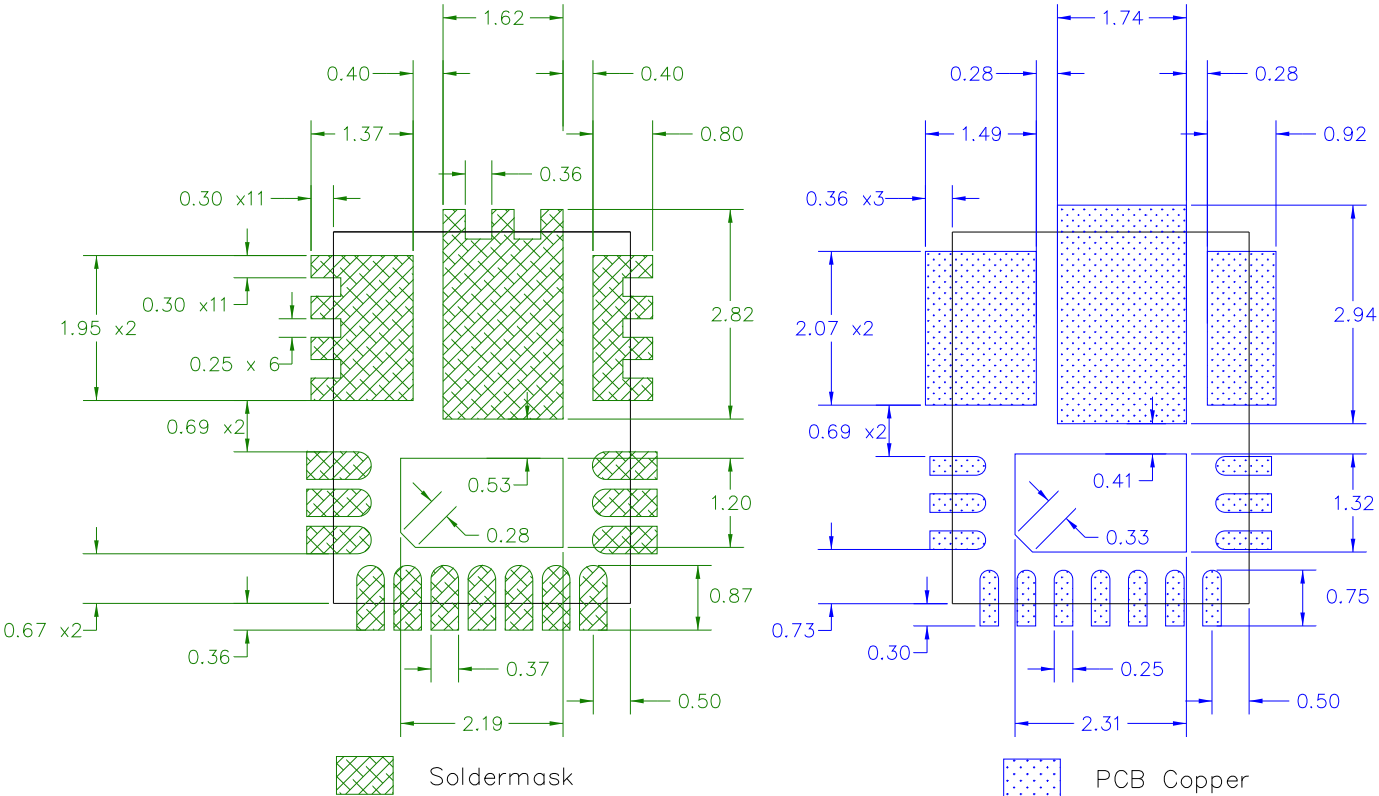


All Dimensions in mm

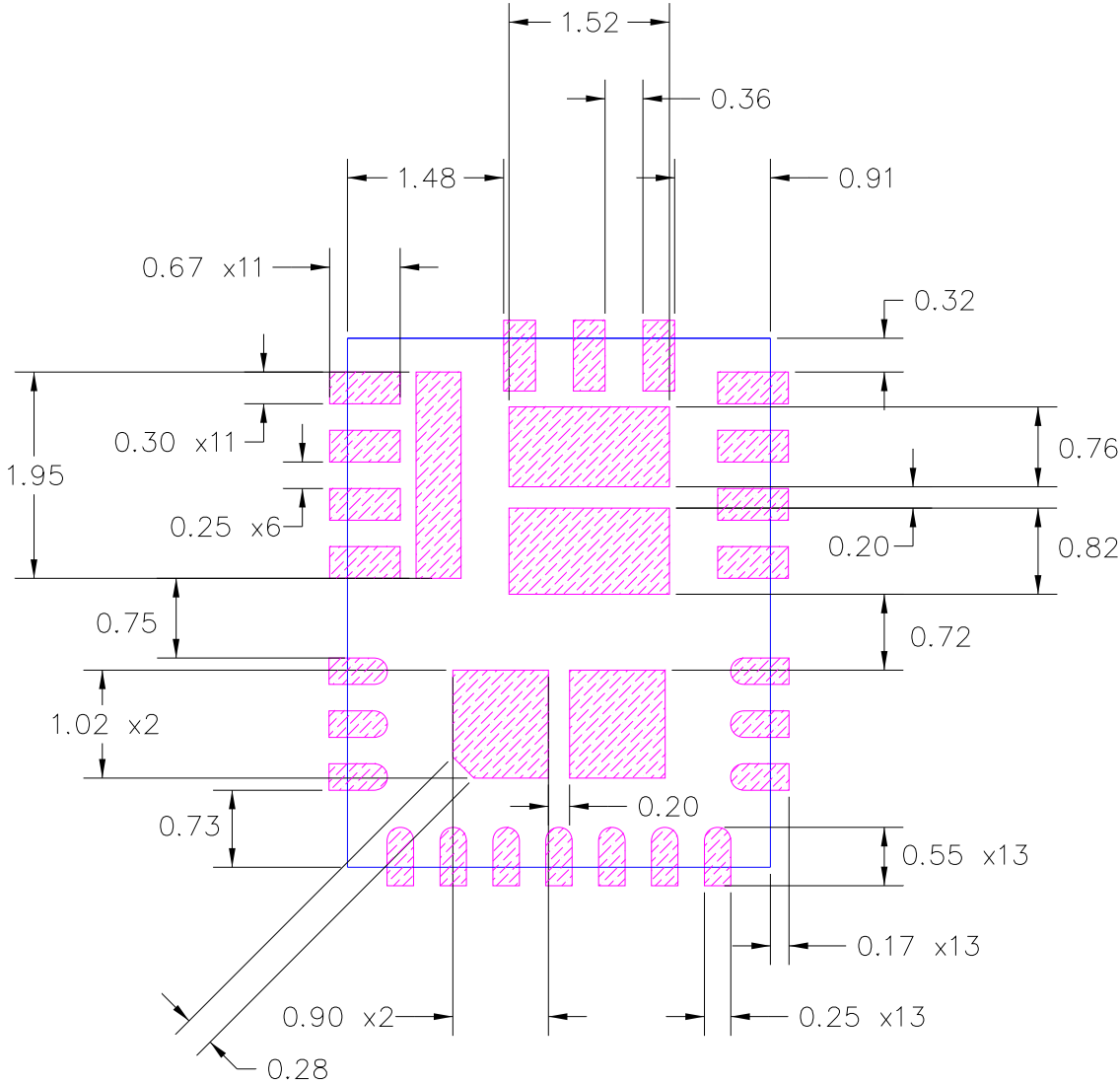
-  PCB Copper
-  Component
-  Soldermask

Solder Resist

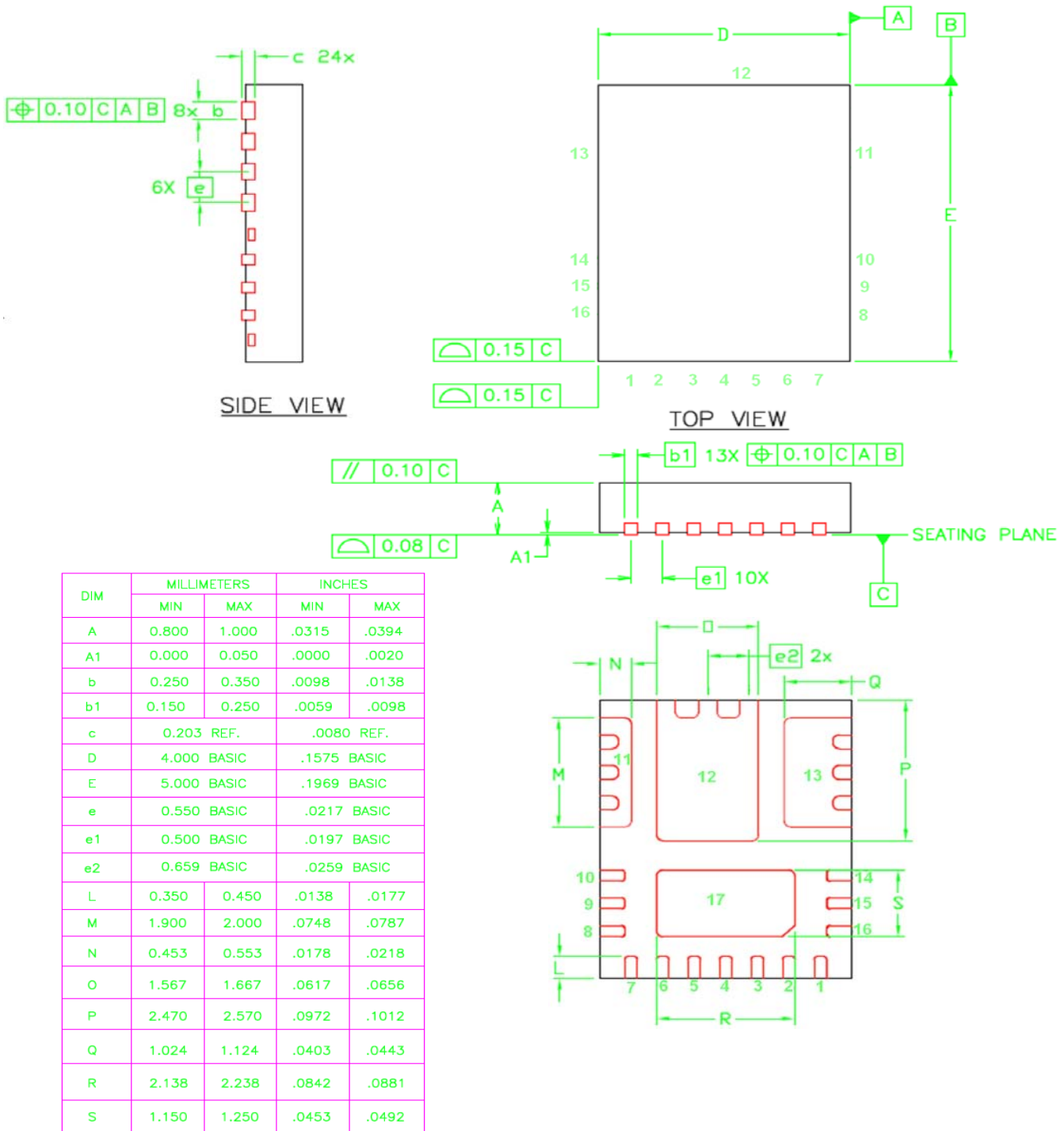
All Dimensions in mm



Stencil Design



Stencil Aperture
All Dimensions in mm



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